Smart Dual Current Sense Switch

Basic Features

- Short circuit protection
- DMOS Overtemperature protection
- Overvoltage protection
- Open load detection
- Current limitation
- Low quiescent current mode
- 3,3V µC compatible input
- **E**lectro**s**tatic **d**ischarge (ESD) protection

Specific Features

- Proportional load current sense
- IC Overtemperature warning
- 8-Bit SPI (for diagnosis and control)
- Short to GND detection
- Programmable overload behaviour

Product Summary

Supply voltage	V_S	4.5 – 5.5 V
Drain source voltage	$V_{DS(AZ)}$	48 - 60 V
On resistance	R_{ON}	0.18 Ω

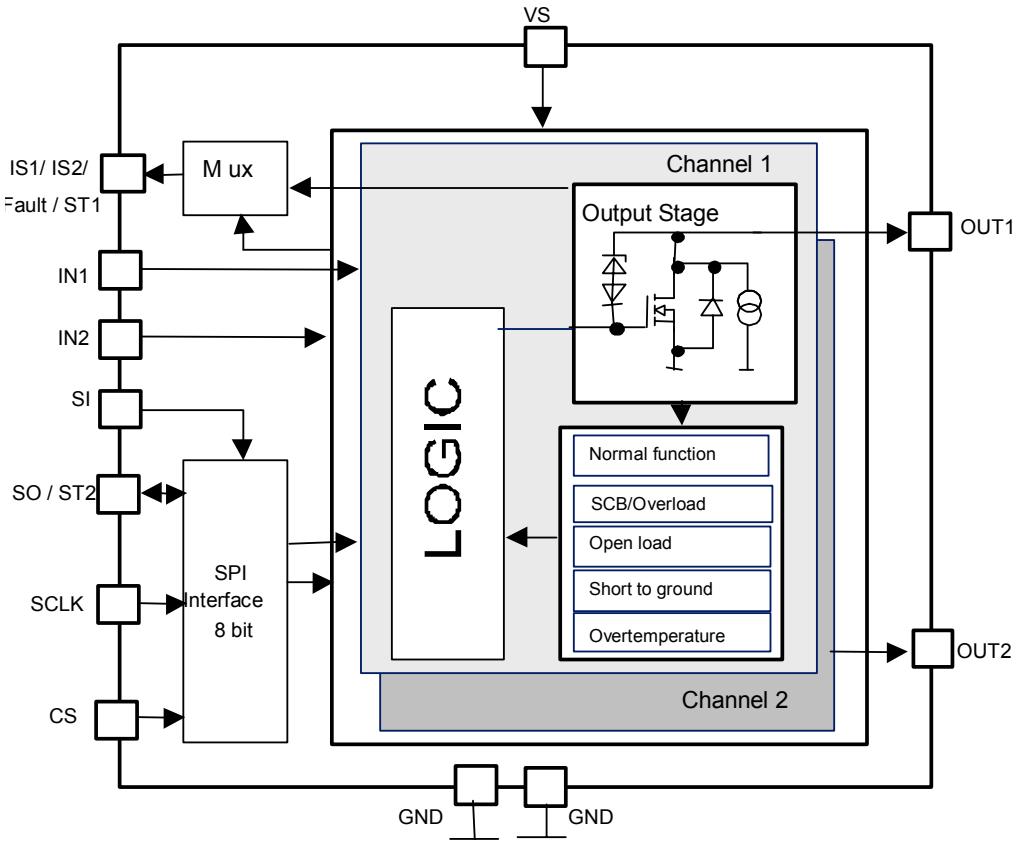
P-DSO-12-4

Ordering Code :Q....

General Description

Dual Current Sense Low-Side Switch in Smart Power Technology (SPT) with two open drain DMOS output stages. The TLE 6214 L is protected by embedded protection functions and designed for automotive applications. The output stages can be controlled directly by parallel inputs for PWM applications (e.g. Oxygen Probe Heater, Stepper Motor) or by SPI. All output stages can provide a load current proportional sense signal. Diagnosis is done by an 8 bit SPI or by one status output per channel.

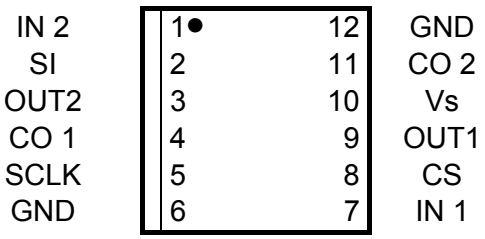
Block Diagram



Pin Description

Pin	Symbol	Function
1	IN2	Input Channel 2
2	SI	SPI Signal In
3	OUT2	Power Output Channel 2
4	CO1	Current Sense 1/2 / Fault / Status Ch1
5	SCLK	SPI Clock
6	GND	Ground
7	IN1	Input Channel 1
8	CS	SPI Chip Select
9	OUT1	Power Output Channel 1
10	VS	Supply Voltage
11	CO2	SPI Signal Out / Status Ch2
12	GND	Ground

Pin Configuration (Top view)

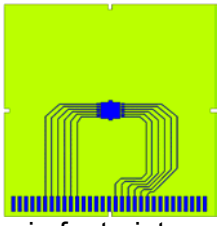


Power P-DSO -12

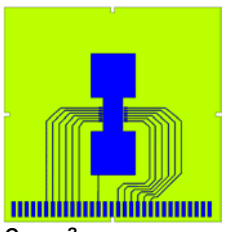
Both GND pins and heat sink must be connected to GND externally.

Maximum Ratings for T_j = – 40°C to 150°C

Parameter	Symbol	Values	Unit
Supply Voltage	V_S	-0.3 ... +7	V
Continuous Drain Source Voltage (OUT1...OUT2)	V_{DS}	-0.3 ... +48	V
Input Voltage, All Inputs and Data outputs, Sense Lines	V_{IN}	- 0.3 ... + 7	V
Output Current per Channel [1)]	I_D	$I_{D(lim1,2)\ min.}$	A
Reverse Current per channel	I_{rev}	-3	A
Output Clamping Energy I_D = 1A	E_{AS}	see character-istic	mJ
Electro**s**tatic **D**ischarge Voltage (human body model) according to MIL STD 883D, method 3015.7 and EOS/ESD assn. standard S5.1 – 1993	V_{ESD}		
Output Pins		4000	V
All other Pins		2000	V
DIN Humidity Category, DIN 40 040		E	
IEC Climatic Category, DIN IEC 68-1		40/150/56	
Thermal resistance			
junction - case	R_{thJC}	2	K/W
junction - ambient @ min. footprint	R_{thJA}	105	K/W
junction - ambient @ 6 cm² cooling area		45	K/W



min footprint



6 cm² copper cooling area

[1)] Output current rating as long as maximum junction temperature is not exceeded. The maximum output current has to be calculated using R_{thJA} according mounting conditions.

Electrical Characteristics

Parameter and Conditions V_S = 4.5V – 5.5V ; T_j = - 40 °C to + 150 °C (unless otherwise specified)		Symbol	Values			Unit
			min	typ	max	
1. Power Supply						
Supply Voltage		V_S	4.5	--	5.5	V
Supply Current		I_S	--		5	mA
Supply Current in Sleep Mode (CS = H)		$I_{S(sleep)}$	--	--	10	µA
Wake up Time (after sleep mode)		t_{wake}			100	µs
2. Power Outputs						
ON Resistance V_S = 5 V; I_D = 2 A	T_J = 25°C	$R_{DS(ON)}$	--	0.18	0.22	Ω
	T_J = 125°C		--	0.27	0.32	
	T_J = 150°C		--	0.3	0.36	
Output Clamping Voltage	output OFF	$V_{DS(AZ)}$	48	--	60	V
Current Limit 1: Current limitation		$I_{D(lim1)}$	5	6.5	8	A
Current Limit 2 :Overload switch off		$I_{D(lim2)}$	9	10,5	12	A
Reverse Current per channel[1]		I_{rev}			2	A
Output Leakage Current	*Sleep mode active*	$I_{D(lkg)}$	--	--	5	µA
Turn-On Time 1	I_D = 2 A, resistive load	t_{ON}	--	5	10	µs
Turn-On Time 2	I_D = 2 A, resistive load			20	50	
Turn-Off Time 1	I_D = 2 A, resistive load	t_{OFF}	--	5	10	µs
Turn-Off Time 2	I_D = 2 A, resistive load			20	50	
Turn On slew rate	U_{DS} 80% to 30%, V_{bat} = 14V	s_{ON}				V/µs
Slew rate 1	I_D = 2 A, resistive load		1	5	20	
Slew rate 2	I_D = 2 A, resistive load			1	5	
Turn Off slew rate	U_{DS} 30% to 80%, V_{bat} = 14V	s_{OFF}				V/µs
Slew rate 1	I_D = 2 A, resistive load		1	5	20	
Slew rate 2	I_D = 2 A, resistive load			1	5	
3. Digital Inputs						
Input Low Voltage		V_{INL}	--	--	1.0	V
Input High Voltage		V_{INH}	2.0	--	--	V
Input Voltage Hysteresis		V_{INHys}	100	200	400	mV
Input Pull Down Current (IN1 ... IN2)		$I_{IN(1..2)}$	20	50	100	µA
Input Pull Down Current (SI, SCLK)		$I_{IN(SI,SCLK)}$	10	20	50	µA
Input Pull Up Current (CS)		$I_{IN(CS)}$	10	20	50	µA
4. Digital Outputs (SO, $\overline{\text{FAULT}}$, Status 1/2)						
SO High State Output Voltage	I_{SOH} = 2 mA	V_{SOH}	V_S - 0.4	--	--	V
SO Low State Output Voltage	I_{SOL} = 2.5 mA	V_{SOL}	--	--	0.4	V

[1] without loss of function, supply current can be I_S > 5mA

Output Tri-state Leakage Current	CS = H, $0 \le V_{SO} \le V_S$	I_{SOlkg}	-10	0	10	µA
FAULT Output Low Voltage	I_{FAULT} = 1.6 mA	V_{FAULTL}	--	--	0.4	V
Status Output Low Voltage	I_{ST} = 1.6 mA	V_{ST}			0.4	V

5. SPI

Serial Clock Frequency (depending on SO load)	f_{SCK}	DC	--	5	MHz
Serial Clock Period (1/fsclk)	$t_{p(SCK)}$	200	--	--	ns
Serial Clock High Time	t_{SCKH}	80	--	--	ns
Serial Clock Low Time	t_{SCKL}	80	--	--	ns
Enable Lead Time (falling edge of CS to rising edge of SCLK)	t_{lead}	200	--	--	ns
Enable Lag Time (falling edge of SCLK to rising edge of CS)	t_{lag}	200	---	--	ns
Data Setup Time (required time SI to falling of SCLK)	t_{SU}	20	--	--	ns
Data Hold Time (falling edge of SCLK to SI)	t_H	20	--	--	ns
Disable Time	t_{DIS}	--	--	150	ns
Transfer Delay Time[1] (CS high time between two accesses)	t_{dt}	300	--	--	ns
Data Valid Time C_L = 50 pF	t_{valid}	--	--	120	ns
C_L = 100 pF		--	--	150	

6. Diagnostic Functions

Open Load Detection Voltage(Channel OFF)	$V_{DS(OL)}$	--	0.6* Vs	--	V
Output Pull Down Current	$I_{PD(OL)}$	25	50	100	µA
Fault Filtering Time	$t_{d(fault)}$	50	100	200	µs
Overload switch off delay time (only current limit 2)	$T_{d(off)}$	10		50	µs
Short to Ground Detection Voltage	$V_{DS(SHG)}$	--	0.4* Vs	--	V
Short to Ground Detection Current(Channel OFF)	I_{SHG}	-50	-100	-150	µA
Under Current Detection Threshold (Channel ON)	$I_{D(OL)}$	100	170	300	mA
Current Limit1; Overload Threshold Current1	$I_{D(lim1)}$	5	6.5	8	A
Current Limit2; Overload Threshold Current2	$I_{D(lim2)}$	9	10,5	12	A
IC Overtemperature Warning	T_w	155	--	185	°C
Hysteresis	$T_{(w)\ hys}$	--	10	--	K
Channel Overtemperature Shutdown	$T_{th(sd)}$	170	--	200	°C
Hysteresis	$T_{(sd)hys}$	--	10	--	K

5. Analog Current Sense Output (IS1 / IS2)

Current Sense Precision (single channel)[2] I_D = 200mA – 1A; $U_{CO1} \ge 2V$	I_{FB} / I_{OUT} P_{IS}	0.8	1.0	1.2	mA / A

[1] This time is necessary between two write accesses. To get the correct diagnostic information, the transfer delay time has to be extended to the maximum fault delay time $t_{d(fault)max}$ = 200µs.

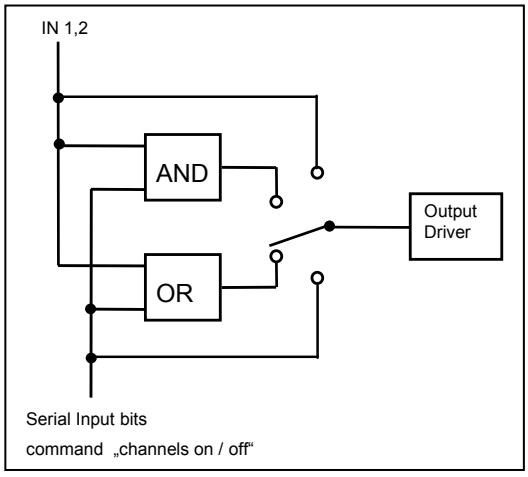
[2] If the summed current is sensed the tolerances of the single channels are added.

Current Sense Precision (single channel)[3] I_D = 1A – 5A; $U_{CO1} \geq 2V$	I_{FB} / I_{OUT}	P_{IS}	0.9	1.0	1.1	mA / A

Functional Description

The TLE 6214 L is a dual-low-side power switch which has two parallel inputs to control the 2 power DMOS switches, as well as by an 8-Bit SPI for control and diagnostic feedback. The power transistors are protected[1)] against short circuit, overload (current limitation), overtemperature and against overvoltage by an active zener clamp. The IC has a load current proportional current output for current control applications.
The diagnostic logic recognises a fault condition which can be read out via the SPI or the parallel status outputs (depending on the IC configuration).

Output Stage Control: Parallel Control or SPI Control
The Output stages can be controlled by parallel Inputs or by SPI command. The IC can be programmed (by SPI) to switch the outputs according to the parallel input signal, to the corresponding SPI command bit or to a combination of these two signals.
Both, parallel inputs and respective SPI databits are high active.



Truth table for Output control

Input control signal Channel n		Output Channel n			
parallel Input	SPI Bit	parallel control	serial control	logic OR	logic AND
0	0	off	off	off	off
0	1	off	on	on	off
1	0	on	off	on	off
1	1	on	on	on	on

Each output is independently controlled by an output latch. A logic high input ‘data bit’ turns the respective output channel ON, a logic low ‘data bit’ turns it OFF.

Switching speed / Slew rate:
The switching speed / slew rate of both channels can be configured by SPI for slow or fast switching speed (1:5) for each channel individually.

Overtemperature Behaviour:
Each channel has an overtemperature sensor and is individually protected against overtemperature. As soon as overtemperature occurs the channel is immediately turned off (without fault filtering time) and the overtmperature information is reported by diagnosis. In this case there are two different behaviours of the affected channel that can be selected by SPI (for all channels generally).
Autorestart: as long as the input signal of the channel remains on (e.g. parallel input high) the channel turns automatically on again after cooling down.
Latching: After overtemperature shutdown the channel stays off until the overtemperature latch is reset by a new L→H transition of the input signal.
Note: The overtemperature sensors of the output channels are only active if the channel is turned on.

As soon as the IC temperature (Temperature of the whole IC) reaches a specified level an overtemperature warning will be indicated.

[1])The integrated protection functions prevent an IC destruction under fault conditions and may not be used in normal operation or permanently.

Low Quiescent current mode (Sleep mode) : By SPI Command the device can be set to Sleep mode. In this mode all outputs are turned off, the diagnosis and biasing is disabled, the diagnosis and the on/off register are reseted and the current consumption drastically reduced. A wake up is done by sending a wake up command by SPI. A specified time (t_{wake}) after this command the IC is fully functional. The configuraton register (exception channel on/off register) values are not influenced by the sleep mode. After wake up the outputs are Off, except the outputs are controlled by parallel inputs.
Overload Protection: The IC can be programmed to react in different ways to overload.
Current limit 1: In this mode the IC active limits the current to the specified "Current Limit 1". If the current limitation is active for longer than the fault filtering time this fault is reported and stored in the Fault register.
Current limit 2: If this current limit is active for more than the specified "Overload switch off delay time" the affected channel is turned off and the fault is reported and stored in the fault register. To turn on the channel again this overload latch has to be reset before with an L→ H transition of the input signal (parallel /SPI depending on the programmed operation).

The two operation modes can be changed during operation of the channel.

Pin description:

OUTPUT 1,2 – Drain pins of the two channels. Output pins and connected to the load.

GND – Ground pins.

IN 1,2 – Parallel Input Pins of the two channels

IS / Fault / ST1 –Configurable output pin. Depending on the configuration (done by SPI command) it has three basic functions:

a) General Fault pin. This is a general fault pin (open drain) which shows a high to low transition as soon as an error is latched into the diagnosis register. When the diagnosis register is cleared this flag is also reset (high state). This fault indication can be used to generate a µC interrupt.
b) Sense Function. In this configuration the analog output signal represents the value of the load current: Sense Current proportional load current channel 1
Sense Current proportional load current channel 2
Sense Current proportional load current of both channels (I_{D1} + I_{D2})
c) Status Output for channel 1: The Status output shows the same level as the input signal of channel 1 as long as there is no error and the inverted input signal when any kind of error occurred at channel 1

VS – Logic Supply pin. Used to supply the integrated circuitry.

CS – Chip Select of the SPI (low active)

SO / ST2 – Configurable output pin. Depending on the configuration (done by SPI command) it has two functions:

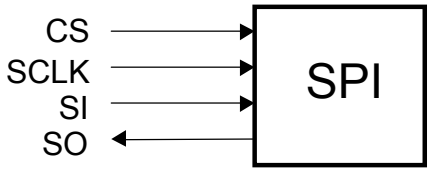
a) Signal Output of the **S**erial **P**eripheral **I**nterface
b) Status Output for channel 2: The Status output shows the same level as the input signal of channel 2 as long as there is no error and the inverted input signal when any kind of error occurred at channel 2

SI – Signal Input of the **S**erial **P**eripheral **I**nterface. The pin has an internal pull down structure.

SCKL – Clock Input of the **S**erial **P**eripheral **I**nterface. The pin has an internal pull down structure

SPI

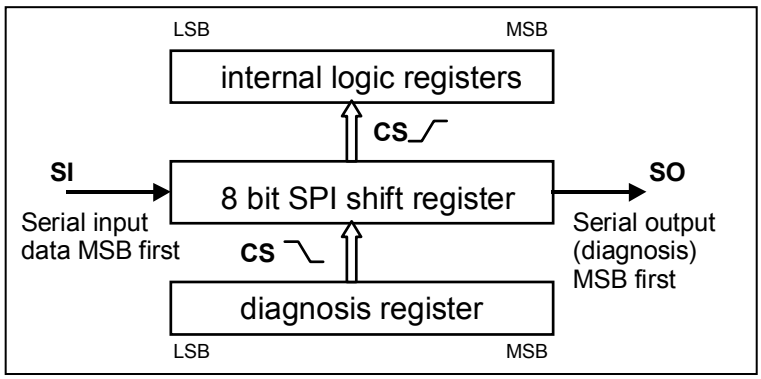
The SPI is a **S**erial **P**eripheral **I**nterface with 4 digital pins and an 8 bit shift register. The SPI is used to configure and program the device, turn on and off channels and to read detailed diagnostic information.



Note: The default setting of the TLE614L is to use the the SO/ST2 pin as status output pin for channel 2. To activate the SO function of the SPI the command "I/O Configure" (see. SPI commands: No.3) has to be used to reconfigure the IC. (e.g. 0111 xxxx)

SPI Signal Description:

CS - Chip Select. The system microcontroller selects the TLE 6214 L by means of the CS pin. Whenever the pin is in a logic low state, data can be transferred from the µC and vice versa.



CS = H : Any signals at the SCLK and SI pins are ignored and SO is forced into a high impedance state.

CS = H→L :

- diagnostic information is transferred from the diagnosis register into the SPI shift register. (in sleep mode no tranfer of diagnostic information)
- serial input data can be clocked into the SPI shift register from then on
- SO changes from high impedance state to logic high or low state corresponding to the SO bits

CS = L : SPI is working like a shift register. With each clock signal at the SCLK pin the state of the SI is read into the SPI shift-register (falling clock edge) and one diagnosis bit is written out of SO (rising rising edge).

CS = L→H:

- transfer of SI bits from SPI shift register into the internal logic registers
- reset of diagnosis register if sent command was valid

To avoid any false clocking the serial clock input pin SCLK should be logic low state during high to low transition of CS.

SCLK - Serial Clock. The serial clock pin clocks the internal SPI shift register of the TLE 6214 L. The serial input (SI) accepts data into the input SPI shift register on the falling edge if while the serial output (SO) shifts diagnostic information out of the SPI shift register on the rising edge of serial clock. It is essential that the SCLK pin is in a logic low state whenever chip select CS makes any transition.

SI - Serial Input. Serial data bits are shifted in at this pin, the most significant bit (MSB) first. SI information is read in on the falling edge . Input data is latched in the SPI shift register and then transferred to the internal registers of the logic.
The input data consist of 8 bit, made up of x control bits and y data bits. The control word is used to program the device, to operate it in a certain mode as well as providing diagnostic information (see SPI Commands).

SO - Serial Output. Diagnostic data bits are shifted out serially at this pin, the most significant bit (MSB) first. SO is in a high impedance state until the CS pin goes to a logic low state. New diagnostic data will appear at the SO pin following the rising edge.

SPI Commands:

No	Command	MSB	6	5	4	3	2	1	LSB
		Command Bits			Data Bits				
1	Diagnosis only	0	0	1	X	X	X	X	X
2	Output Configure	0	1	0	I_{lim} Ch2	I_{lim} Ch1	Restart /Latch	Slewrate Ch2	Slewrate Ch1
3	I/O Configure	0	1	1	Status / SPI	Parallel / Serial Input		Fault / Sense	
4	Reset Registers	1	0	0	X	X	X	X	X
5	Sleep Mode	1	0	1	X	X	X	X	X
6	Wake Up	1	1	0	X	X	X	X	X
7	Channels on (1) / off (0)	1	1	1	Ch2	Ch1	X	X	X
8	No command	0	0	0	X	X	X	X	X

Command description: (default values are bold print)

1. Diagnosis Only : Reads out the diagnosis register. This command has no other influence on the device.

2. Output Configure : Configures the behaviour of the Power Outputs.

I_{lim} Ch1: overload behaviour of channel 1
- **0: Current limit 2 is activated** (default)
- 1: Current limit 1 is activated

I_{lim} Ch2: overload behaviour of channel 2
- **0: Current limit 2 is activated**(default)
- 1: Current limit 1 is activated

Restart / Latch: overtemperature behaviour of the IC
- **0: Automatic autorestart of a channel after cooling down**(default)
- 1: Latching "off" of a channel at overtemperature

Slew rate: Switching slew rate of channel 1 and 2
- **0: fast switching (slew rate 1)** (default)
- 1: slow switching (slew rate 2)

3. I/O Configure : Configures the behaviour of the I/O Ports.

Status / SPI : Output of diagnostic information of the IC
- **0: Diagnosis output serial with one status output per channel (ST1, ST2)**
- 1: Diagnosis output with SPI (SO) and Fault Pin / Sense Pin

Parallel / Serial Input : Control of the output channels

bit3 bit2
- **0 0 : Control of channel 1 and 2 with parallel input (IN1, IN2)** (default)
- 0 1 : Control of channel 1 and 2 with combination (OR) of serial and parallel input signal
- 1 0 : Control of channel 1 and 2 with combination (AND) of serial and parallel input signal
- 1 1 : Control of channel 1 and 2 only with SPI

Sense / Fault : Function of the Sense / Fault / ST1 output

bit1 bit0
- **0 0 : Pin function is "general Fault pin"**(default)
- 0 1 : Pin function is current sense output channel 1 (I_{IS1})
- 1 0 : Pin function is current sense output channel 2 (I_{IS2})
- 1 1 : Pin function is current sense output channel 1 + 2 (I_{IS1} + I_{IS2})

4. Reset Registers : Sets back all internal registers. Logic registers to default and Fault registers to no error.
Default settings after Reset:

Parallel Input control
Autorestart
Status Outputs ST1 and ST2 active
Current Limit 2
Channel ON/OFF register “OFF”
Slew rate fast

5. Sleep mode : Activates the low quiescent mode. In sleep mode only the command “wake up” is valid. Other commands will not lead to any reactions. Wake up is done by the Wake Up command or by undervoltage reset.

6. Wake Up : Deactivates the low quiescent mode. A specified time (t_{wake}) after this command the IC is fully functional.

7. Channels on / off : Turns on / off the power outputs (if configured for serial control)

Ch1 : Serial control bit of channel 1
0: **Output off**(default)
1: Output on

Ch2 : Serial control bit of channel 2
0: Output off(default)
1: Output on

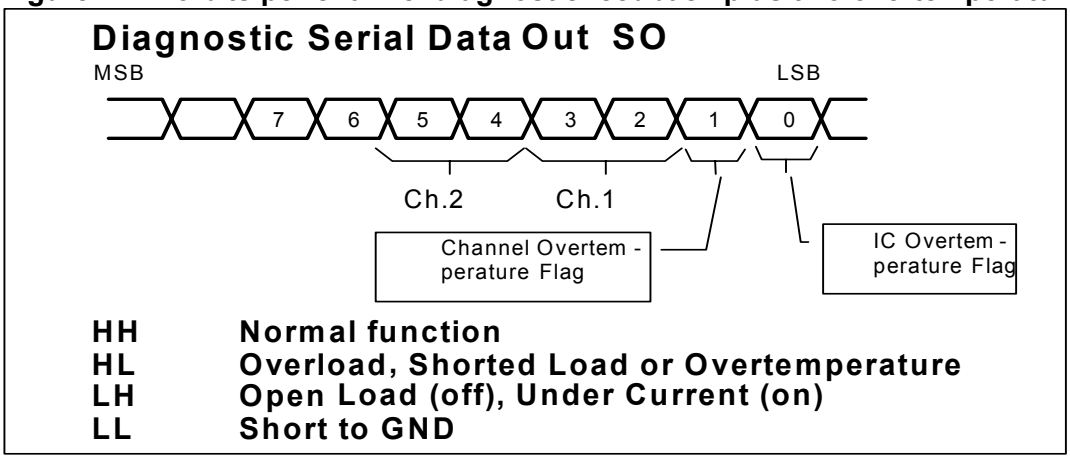
After activation of the low quiescent mode by the “sleep” command, the outputs are turned off and the serial control register is set to default values.

8. No Command : No valid command and will not lead to an reaction (register value change, switching channels, ...) of the IC. After Chip Select giong L→H the diagnosis register will not be reset.

SPI Diagnostics:

As soon as a fault occurs for longer than the fault filtering time (exept Overtemperature; no filtering time), the fault information is latched into the diagnosis register (and the Fault pin will change from high to low state). A new error on the same channel will over-write the old error report. Serial data out pin (SO) is in a high impedance state when CS is high. If CS receives a LOW signal, all diagnosis bits can be shifted out serially. If the sent command was valid the rising edge of CS will reset all diagnosis registers and restart the fault filtering time. In case of an invalid command the device will ignore the data bits and the diagnosis register will not be reset at the rising CS edge.

Figure 1: Two bits per channel diagnostic feedback plus two overtemperature flags



For Full Diagnosis there are two diagnostic bits per channel configured as shown in Figure 1. Bit 6 and bit 7 of the diagnostic register are not used and always H.

Normal function: The bit combination **HH** indicates that there is no fault condition, i.e. normal function.
Overload, Shorted Load or Overtemperature: HL is set when the current limitation gets active, i.e. there is a overload, short to supply or overtemperature condition. The second reason for this bit combination is overtemperature of the corresponding channel.
Open load/ Under current: LH is set when open load (in off state of the channel) or under current (in on state of the channel) is detected
Short to GND : LL is set when this condition is detected (in off state)
Channel Overtemperature Flag: In case of overtemperature in any output channel in on state the overtemperature Flag in the SPI diagnosis register is set. This Bit can be used to distinguish between Overload and Overtemperature (both HL combination).
IC Overtemperature Warning Flag: When the IC logic temperature exceeds typ.170° the IC Overtemperature Warning Flag will be set in the SPI diagnosis register.

Parallel Status Output Diagnostics :

Parallel diagnostic outputs (open drain) change state according to the input signal of the corresponding channel. As soon as an error occurs at the corresponding channel (Overload, Overtemperature and Under current is detected in on state and Open load, short to GND also in off state) the Status output shows the inverted input signal. A fault is detected only if it lasts for longer than the fault filtering time. This fault information is not latched.

Diagnostic Table

In general the status follows the input signal in normal operating conditions.
If any error is detected the status is inverted.

Operating Condition		Con-trol Input	Power Output	Filter time	Status Output	FAULT Output	SPI diagnostic feedback		
							Channel Diagnostic bits MSB	Channel Diagnostic bits LSB	Channel overtemp. flag
Sleep Mode		X	off		L	H	-	-	-
Normal function		L	off		L	H	H	H	L
		H	on		H	H	H	H	L
Short to ground[1]	"off"	L	off	td(fault)	H	L	L	L	L
		H	on	td(fault)	L	L	L	H	L
Open load[1]	"off"	L	off	td(fault)	H	L	L	H	L
Under current[1]	"on"	H	on	td(fault)	L	L	L	H	L
Overload or short to supply[1] (Current limit 1 / Limitation)		H	on	td(fault)	L	L	H	L	L
Overload or short to supply[2] (Current limit 2 / Shutoff)		H	off	td(off)	L	L	H	L	L
Overtemperature (Restart mode)		H	off [3]	no	L	L	H	L	H
Overtemperature (Latch mode)		H	off [4]	no	L	L	H	L	H

Note 1) Short to ground/open load/ under current /overload/short-to-supply - events shorter than min. time td(fault) will not be latched and not reported at the diagnosis pins.

Note 2) Overload/short-to-supply - events shorter than min. time td(off) will not be latched and not reported at the diagnosis pins.

Note 3) Off as long as overtemperature occurs, restart after cooling down.

Note 4) Shutdown latch reset by falling input edge

Analog Current Sensing :

The TLE6214L provides an analog current sensing function for both output channels. By SPI configuration the multifunctional pin CO1 can sink a sense current proportional to the load current of one/ both of the two output channels[1)]. The specified current range and accuracy is described in the electrical characteristics “5.Analog Current Sense Output”. To achieve the specified accuracy for current sensing the voltage at the CO1 pin must always be $U_{CO1} \geq 2V$.

Timing Figures

Figure 5: Power Outputs and Status

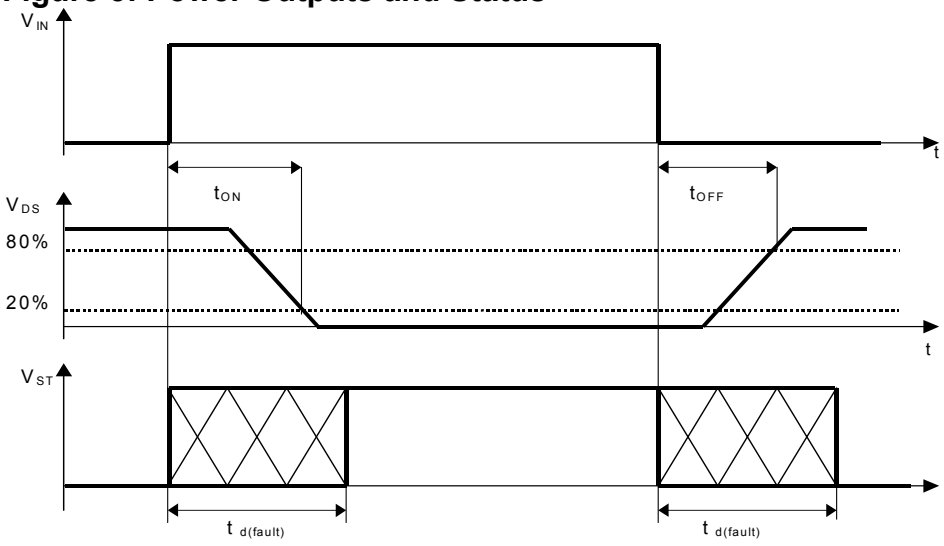
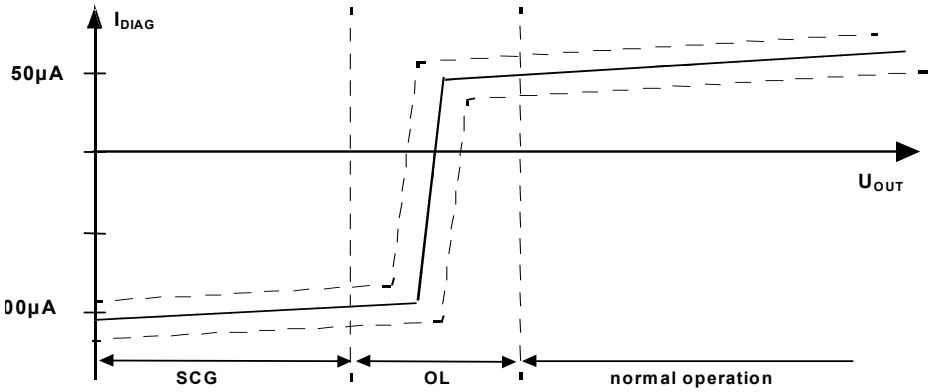


Figure 6: Open load (off) and Short to GND Diagnostics



[1)] At a low load current (<<200mA) and IC configured for current sense function an offset current at the CO1 occurs (typ. I_S= 40µA @ I_D=0A).

Figure 7: Serial Interface Timing Diagram

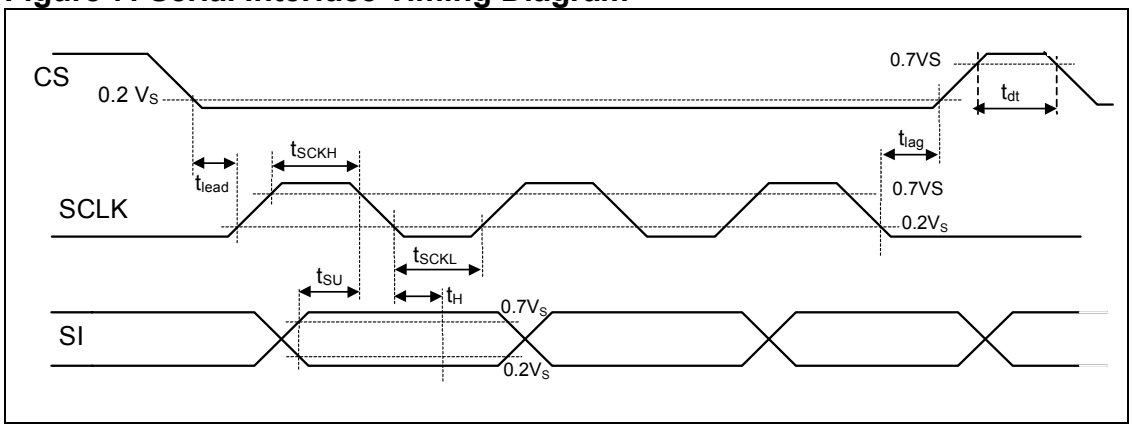
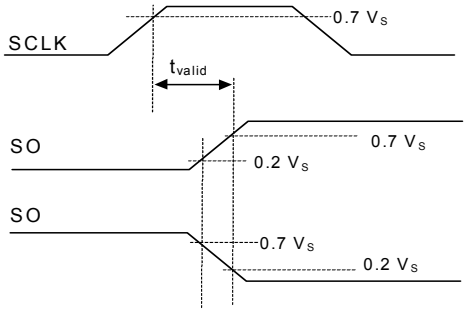
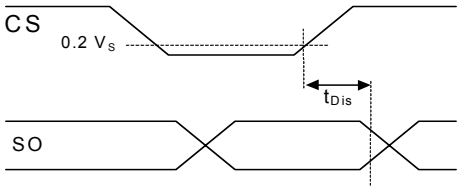


Figure 8: Input Timing Diagram

SO Valid Time Waveforms

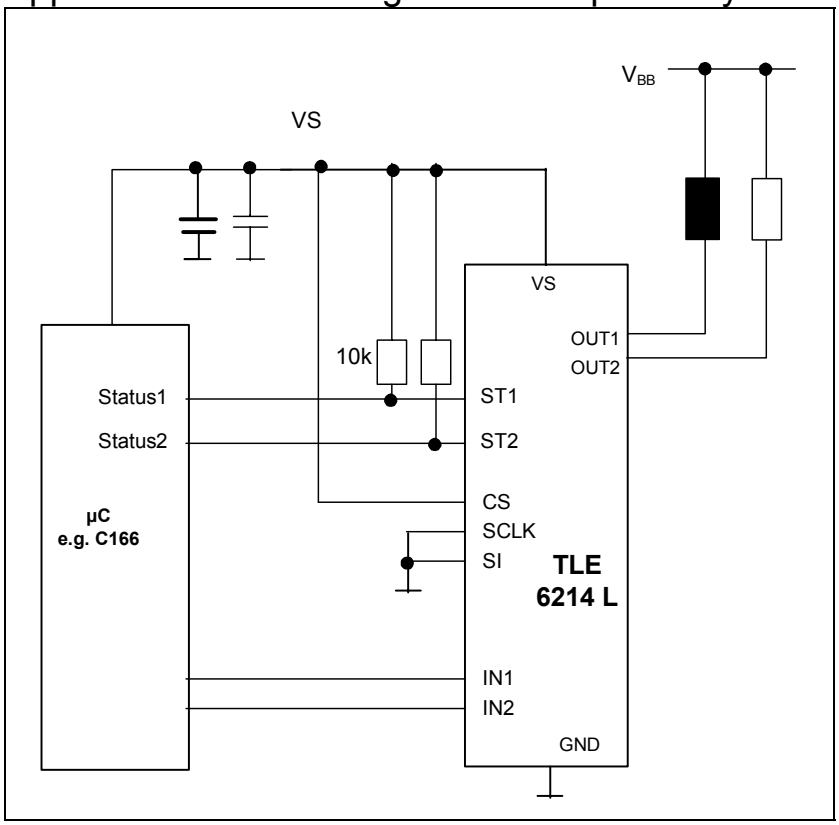


Enable and Disable Time Waveforms

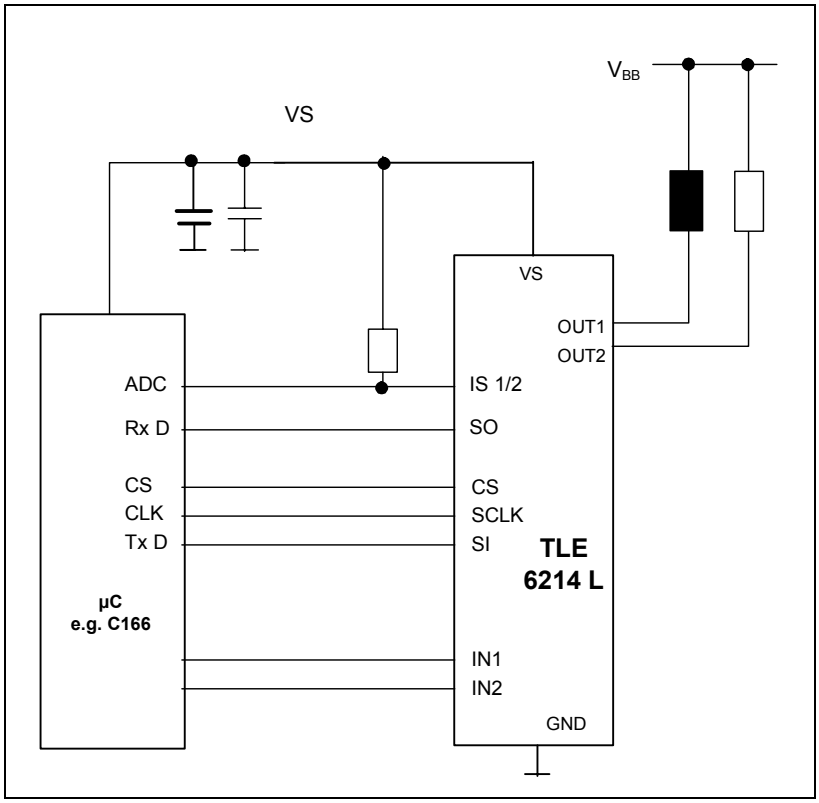


Application Circuits

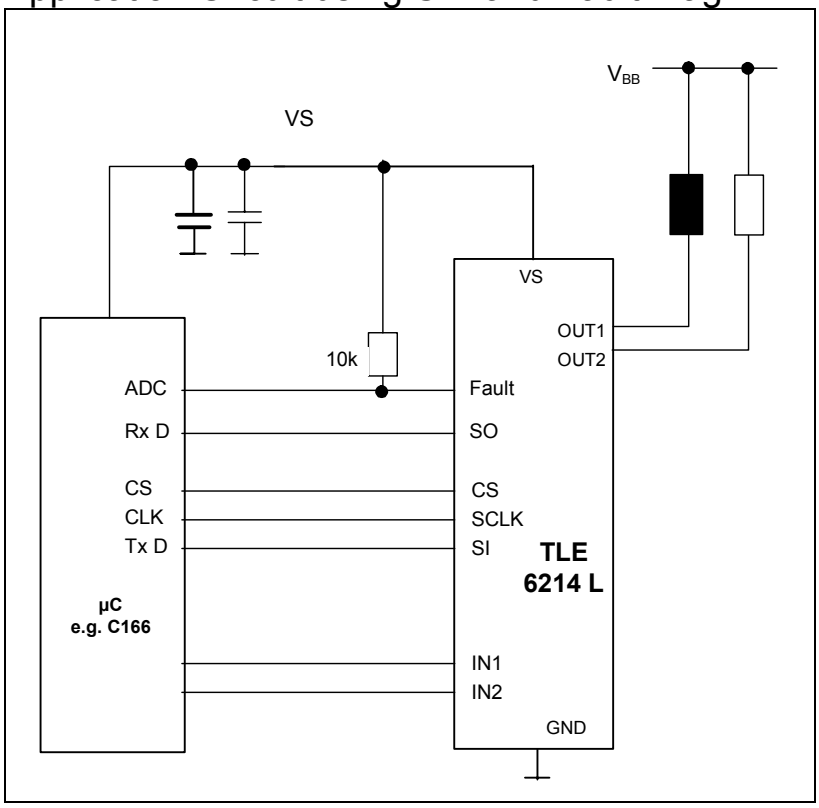
Application Circuit using Status Outputs only



Application Circuit using SPI and Current Sense Output

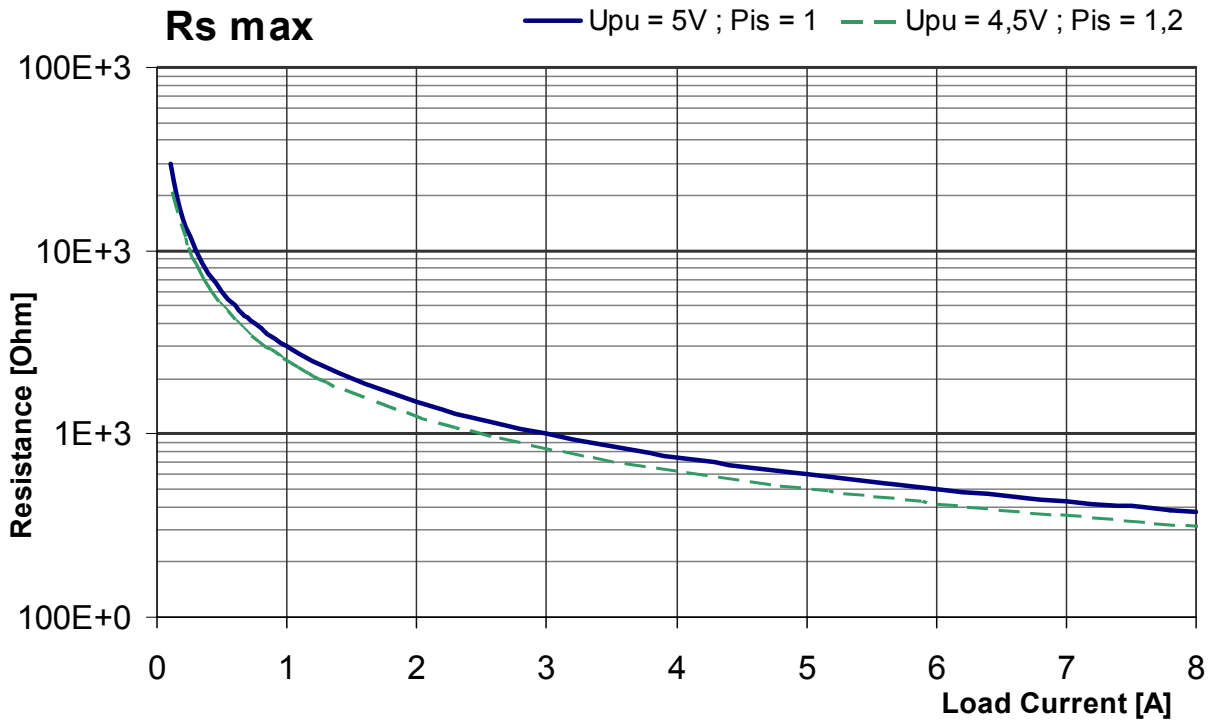


Application Circuit using SPI and Fault Flag

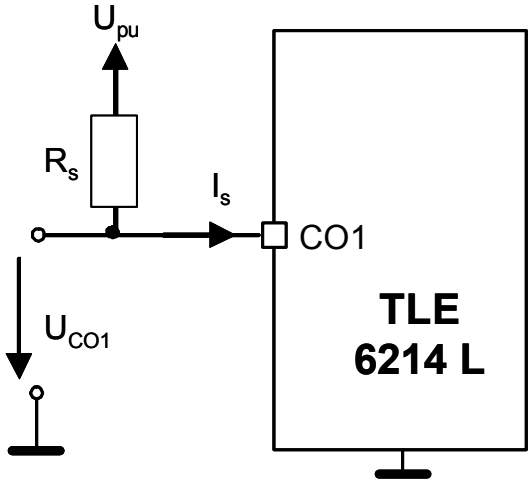


Typical Characteristics

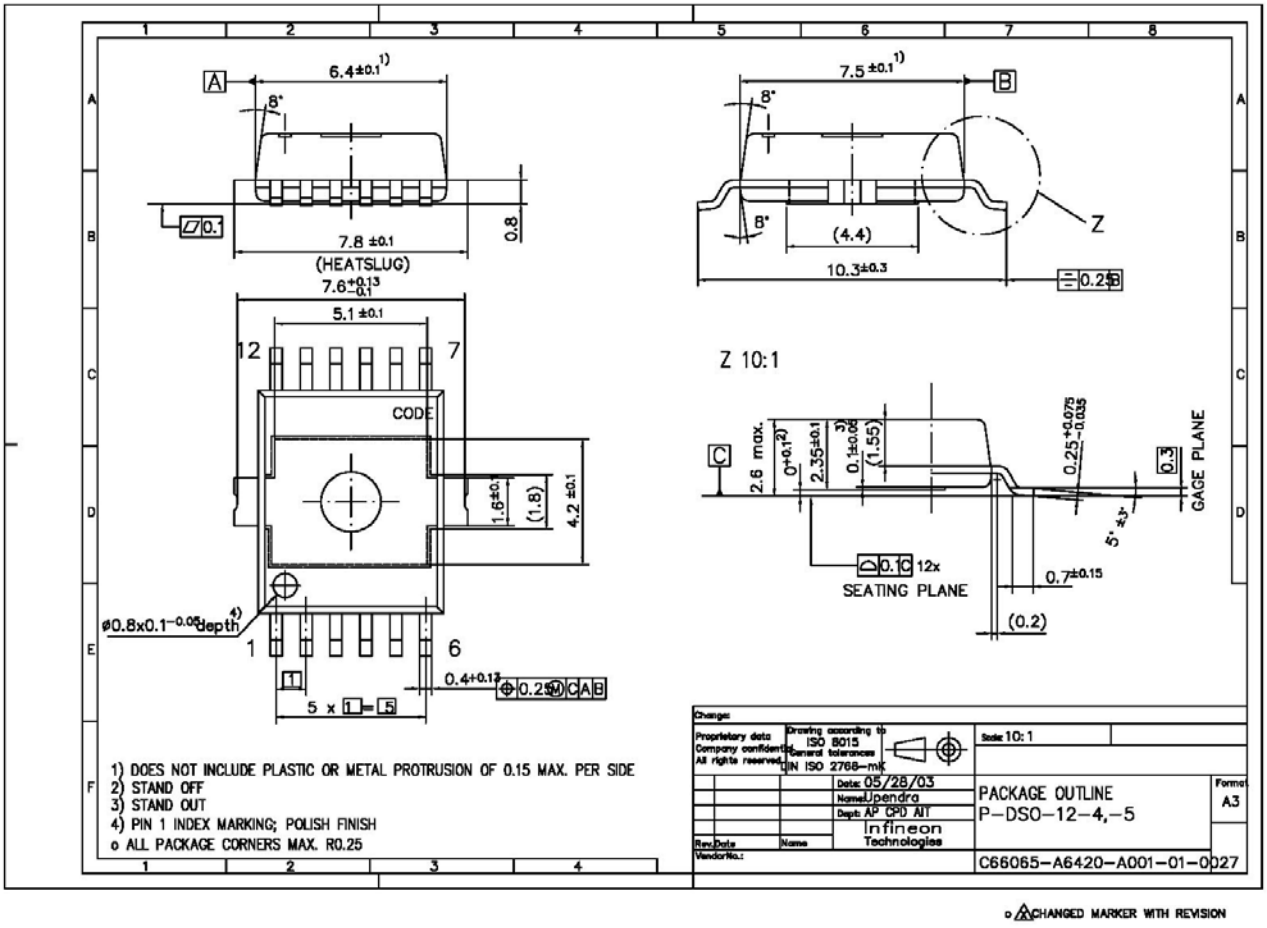
Maximum Sense Resistor vs. Load Current



Circuit proposal for current sensing



Package and Ordering Code



(all dimensions in mm)

P - DSO - 12 - 4	Ordering Code
TLE 6214 L	Q-A.....

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